

## 2.5MHz, Synchronous Boost Regulator with Bypass Mode

### **General Description**

The RT4803 allows systems to take advantage of new battery chemistries that can supply significant energy when the battery voltage is lower than the required voltage for system power ICs. By combining built-in power transistors, synchronous rectification, and low supply current; this IC provides a compact solution for systems using advanced Li-Ion battery chemistries.

The RT4803 is a boost regulator designed to provide a minimum output voltage from a single-cell Li-Ion battery, even when the battery voltage is below system minimum. In boost mode, output voltage regulation is guaranteed to a maximum load current of 2A. Quiescent current in Shutdown Mode is less than 1µA, which maximizes battery life. The regulator transitions smoothly between Bypass and normal Boost Mode. The device can be forced into Bypass Mode to reduce quiescent current.

The RT4803 is available in the WL-CSP-16B 1.67x1.67 (BSC) package.

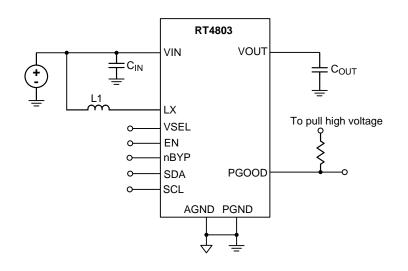
### Features

- 4 Few External Components : 0.47µH Inductor and 0603 Case Size Input and Output Capacitors
- Input Voltage Range : 1.8V to 5V
- Output Range from 2.85V to 4.4V
  - ▶ VSEL = L 3.3V
  - ▶ VSEL = H 3.55V
- Maximum Continuous Load Current : 2A at V<sub>IN</sub> > 2.65V Boosting VOUT to 3.35V
- Up to 96% Efficient
- True Bypass Operation when V<sub>IN</sub> > Target V<sub>OUT</sub>
- Internal Synchronous Rectifier
- Soft-Start with True Load Disconnect
- Forced Bypass Mode
- V<sub>SEL</sub> Control to Optimize Target V<sub>OUT</sub>
- Short-Circuit Protection
- I<sup>2</sup>C Controlled Interface
- Ultra low Operating Quiescent Current
- Small WL-CSP 16B Package
- Discharge Function

### Applications

- Single-Cell Li-Ion, LiFePO4 Smart-Phones or Tablet
- 2.5G/3G/4G Mini-Module Data Cards

### **Simplified Application Circuit**



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### **Ordering Information**

### RT4803 📮

```
└─Package Type
WSC : WL-CSP-16B 1.67x1.67 (BSC)
```

#### Note :

Richtek products are :

- ► RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ► Suitable for use in SnPb or Pb-free soldering processes.

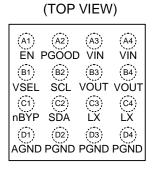
### **Marking Information**

0GW

0G : Product Code W : Date Code

**Functional Pin Description** 

### **Pin Configuration**



WL-CSP-16B 1.67x1.67 (BSC)

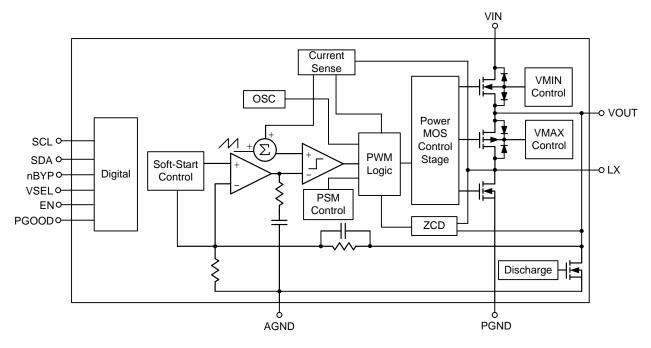
Pin No.	Pin Name	Pin Function
A1	EN	Enable. When this pin is HIGH, the circuit is enabled.
A2	PGOOD	Power good. It is a open-drain output. PGOOD pin pulls low automatically if the overload or OTP event occurs.
A3, A4	VIN	Input voltage. Connect to Li-Ion battery input power source.
B1	VSEL	Output voltage select. When boost is running, this pin can be used to select output voltage
B2	SCL	Serial interface clock. (Pull down if I <sup>2</sup> C is non-used).
B3, B4	VOUT	Output voltage. Place $C_{OUT}$ as close as possible to the device.
C1	nBYP	Bypass. This pin can be used to activate Forced Bypass Mode. When this pin is LOW, the bypass switches are turned on and the IC is otherwise inactive.
C2	SDA	Serial interface date line. (Pull down if I <sup>2</sup> C is non-used).
C3, C4	LX	Switching node. Connect to inductor.
D1	AGND	Analog ground. This is the signal ground reference for the IC. All voltage levels are measured with respect to this pin.
D2, D3, D4	PGND	Power ground. This is the power return for the IC. The $C_{OUT}$ bypass capacitor should be returned with the shortest path possible to these pins.





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### **Functional Block Diagram**





### Operation

The RT4803 combined built-in power transistors, synchronous rectification, and low supply current, it provides a compact solution for system using advanced Li-lon battery chemistries.

In boost mode, output voltage regulation is guaranteed to a maximum load current of 2A. Quiescent current in Shutdown mode is less than  $1\mu A$ , which maximizes battery life.

Mode		Depiction	Condition		
LIN 1 Line		Linear startup 1	V <sub>IN</sub> > V <sub>OUT</sub>		
	LIN 2	Linear startup 2	VIN > VOUT		
Soft-	Start	Boost soft-start	$V_{OUT} < V_{OUT(MIN)}$		
Boos	t	Boost mode	Vout = Vout(MIN)		
Вура	SS	Bypass mode	$V_{\text{IN}} > V_{\text{OUT}(\text{MIN})}$		

#### LIN State

When  $V_{IN}$  is rising, it enters the LIN State. There are two parts for the LIN state. It provides maximum current for 1A to charge the C<sub>OUT</sub> in LIN1, and the other one is for 2A in LIN2. By the way, the EN is pulled high and  $V_{IN} > UVLO$ .

As the figure shown, if the timeout is over the specification, it will enter the Fault mode.

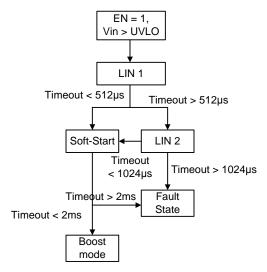


Figure 1. RT4803 State Chart

#### Startup and Shutdown State

When  $V_{IN}$  is rising and through the LIN state, it will enter the Startup state. If EN is pulled low, any function is turned-off in shutdown mode.

#### Soft-Start State

It starts to switch in Soft-start state. After the LIN state, output voltage is rising with the internal reference voltage.

There is a point, it will go to fault condition, if the large output capacitor is used and the timeout is over 2ms after the soft-start state.

#### Fault State

As the Figure 1 shown, it will enter to the Fault state as below,

- The timeout of LIN2 is over the  $1024\mu s$ .
- ► It is over the 2ms when the state changed from Soft-start state to Boost mode.

It will be the high impedance between the input and output when the fault is triggered. A restart will be start after 1ms.

#### **Boost Mode**

There are two normal operation modes, one is the Boost mode, and the other one is Bypass mode. In the Boost mode, it provides the power to load by internal synchronous switches after the soft-start state.

#### **Bypass Mode**

In Bypass mode, the differential voltage between  $V_{IN}$  and  $V_{OUT}$  is 250mV. Output voltage will increase when the input voltage is rising after the soft-start state.

### **Bypass Mode Operation**

In automatic mode, it transits from Boost mode to Bypass mode. As the Figure 2 shown, there are three MOSFET (Q1 to Q3). The Q1 & Q2 is for Boost mode, it is used by Q3 for Bypass mode. V<sub>OUT</sub> will be followed the V<sub>IN</sub> when V<sub>IN</sub> is higher than the target output voltage. As the Figure 3 shown, it is transited by bypass MOSFET (Q3). V<sub>OUT</sub> followed the V<sub>IN</sub>.

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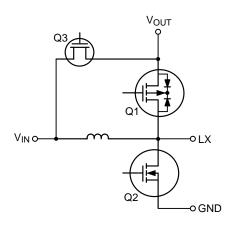


Figure 2. Boost Converter With Bypass Mode

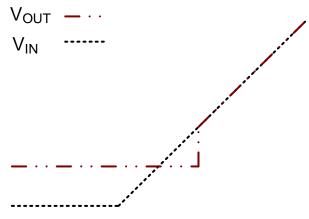


Figure 3. RT4803 mode changed

### Force Pass-Through Mode

When EN pulled high and nBYP pulled low. The device is active in the Force pass-through mode. It supplies current is approximately  $15\mu$ A typ. From the battery, the device is short circuit protected by a current limit of 4000mA.

### VSEL

It is concerned the minimum output voltage at the heavy load condition. There are two output voltage levels (3.3V & 3.55V) in Boost mode and Bypass mode. It can be selected by VSET, so it must not be floating.

### PGOOD (Power Good)

Power good is a open-drain input. If it is 0, it stands for fault occurred. The power good provide the information to show the state of the system,

- PGOOD pin show high when the sequence of soft-start is completed.
- Any fault cause PGOOD to be pulled low.
- PGOOD low when PMIS current limit has triggered for OR the die the temperature exceeds 120°C.
   PGOOD is re-asserted when the device cools below to 100°C.

### OCP

The converter senses the current signal when the high-side P-MOSFET turns on. As a result, the OCP is cycle by-cycle current limitation. If the OCP occurs, the converter holds off the next on pulse until inductor current drops below the OCP limit.

### ΟΤΡ

The converter has an over-temperature protection. When the junction temperature is higher than the thermal shutdown rising threshold, the system will be latched and the output voltage will no longer be regulated until the junction temperature drops under the falling threshold.

### EN & nBYP

It is used to select mode. As the table 1 shown, there are four device states.

If the EN pull low, and nBYP pull high/low, the RT4803 is forced in shut-down mode and the quiescent is less than 1 $\mu$ A. It works in force pass-through mode, if the EN set high and nBYP set low. When EN and nBYP both pull high, the RT4803 is normal operation and enter automatic mode. There should be a delay time (> 60 $\mu$ S) from EN pull high to nBYP pull high to guarantee normal automatic mode operation.

### Discharge

The RT4803 features the discharge function to release the output power when the EN pin goes low condition.

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### RICHTEK

Table 1							
EN input	nBYP Input	Device State					
0	0/1	The device is shut down and the shut down current is down to $1\mu A$ .					
1	0	The device is active in forced pass-through mode. The device supply current is approximately 15µA typ. From the battery. The device is short circuit protected by a current limit of ca. 4000mA.					
1	1	The device is active in auto mode (dc/dc boost, pass-through mode) The device supply current is approximately $65\mu A$ typ. from the battery					

### Absolute Maximum Ratings (Note 1) • VIN, VOUT to AGND ------ -0.2V to 6V • EN, VSEL, PGOOD, nBYP to AGND ------ -0.2V to 6V • LX ------ (PGND - 0.2V) to 6V Power Dissipation, P<sub>D</sub> @ T<sub>A</sub> = 25°C WL-CSP-16B 1.67x1.67 (BSC) ------ 2.09W Package Thermal Resistance (Note 2) WL-CSP-16B 1.67x1.67 (BSC), θJA ------ 47.7°C/W Lead Temperature (Soldering, 10 sec.)------ 260°C • Junction Temperature ------ 150°C ESD Susceptibility (Note 3) HBM (Human Body Model) ----- 2kV MM (Machine Model)------ 200V CDM (Charge Device Model)------ 1kV

### Recommended Operating Conditions (Note 4)

Input Voltage Range	1.8V to 5V
Output Voltage Range	2.85V to 4.4V
Ambient Temperature Range	–40°C to 85°C
Junction Temperature Range	–40°C to 125°C

### **Electrical Characteristics**

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(VIN = 3V,	VOUT = 3.55V,	$IA = 25^{\circ}C$	uniess o	inerwise s	peciliea)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
VIN Operation Range	Vin		1.8		5	V
VIN Quiescent Current	lq	Auto Bypass Mode, V <sub>IN</sub> = 3.8V		40	70	μΑ
VIN Quiescent Current	IQ	Boost mode, $I_{LOAD} = 0mA$ , Switching, $V_{IN} = 3V$		65	100	μA
VIN Quiescent Current	lq	Force Bypass , V <sub>IN</sub> = 3.6V		15	25	μΑ
VIN Shutdown Current	I <sub>SHDN</sub>	EN = 0V, V <sub>IN</sub> = 3.6V			1	μA
VOUT to VIN Reverse Leakage	I <sub>LK</sub>	Vout = 5V, EN = nBYP = H, Vin < Vout		0.2	1	μΑ
VOUT Discharge Impedance	R_DIS_OUT	EN = L		80		Ω
Under Voltage Lock Out	VUVLO	V <sub>IN</sub> Rising		1.6	1.8	V
Under Voltage Lock Out Hysteresis	Vuvlo_hys			200		mV
PGOOD Low	Vpgood	I <sub>PGOOD</sub> = 5mA			0.4	V
PGOOD Leakage Current	IPGOOD_LK	Vpgood = 5V			1	μA
Logic Level High EN, VSEL, nBYP, SCL, SDA	VIH		1.2			V

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Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
Logic Level Low EN, VSEL, nBYP, SCL, SDA	VIL				0.4	V
Output Voltage Accuracy	V <sub>REG</sub>	V <sub>OUT</sub> – V <sub>IN</sub> > 100mV, PWM	-2		2	%
Minimum On Time	T <sub>ON</sub>	$V_{\text{IN}} = 3V, V_{\text{OUT}} = 3.5V,$ $I_{\text{LOAD}} > 1000\text{mA}$		80		ns
Maximum Duty Cycle	DMAX		40			%
Switching Frequency	Fsw	$V_{IN} = 2.65V, V_{OUT} = 3.5V,$ $I_{LOAD} = 1000mA$	2	2.5	3	MHz
Boost Valley Current Limit	ICL	V <sub>IN</sub> = 2.9V	4.4	5	5.6	Α
Soft-Start Input Current Limit	ISS_PK	LIN1		1000		mA
Soft-Start Input Current Limit	ISS_PK	LIN2		2000		mA
Pass Through Mode Current Limit	IBPCL	V <sub>IN</sub> = 3.2V		4		А
N-channel Boost Switch RDS(ON)	RDSN	V <sub>IN</sub> = 3.2V, V <sub>OUT</sub> = 3.5V		60	95	mΩ
P-channel Boost Switch RDS(ON)	R <sub>DSP</sub>	V <sub>IN</sub> = 3.2V, V <sub>OUT</sub> = 3.5V		40	80	mΩ
N-channel Bypass Switch R <sub>DS(ON)</sub>	R <sub>DSP_BYP</sub>	V <sub>IN</sub> = 3.2V, V <sub>OUT</sub> = 3.5V		40	60	mΩ
Hot Die Trigger Threshold	T <sub>HD</sub>			100		°C
Hot Die Release Threshold	T <sub>HDR</sub>			90		°C
Over Temperature Protection	T <sub>OTP</sub>			160		°C
Over Temperature Protection Hysteresis	T <sub>OTP_HYS</sub>			20		°C
FAULT Restart Time	T <sub>RST</sub>			1		ms

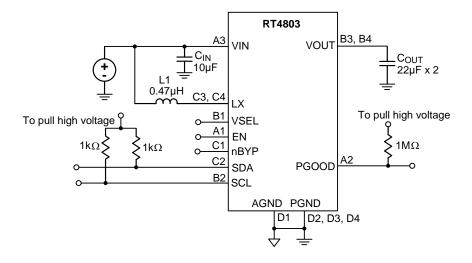
**Note 1.** Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Note 2.  $\theta_{JA}$  is measured at  $T_A = 25^{\circ}C$  on a high effective thermal conductivity four-layer test board per JEDEC 51-7.

Note 3. Devices are ESD sensitive. Handling precaution recommended.

Note 4. The device is not guaranteed to function outside its operating conditions.

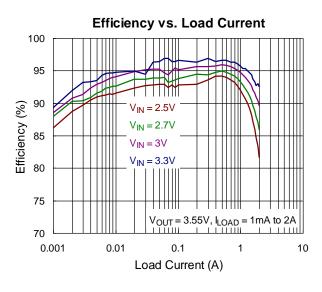
### **Typical Application Circuit**



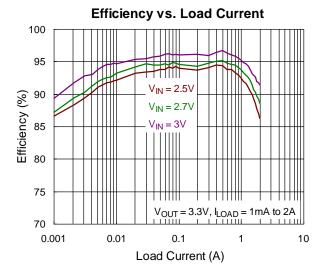
#### **BOM of Test Board**

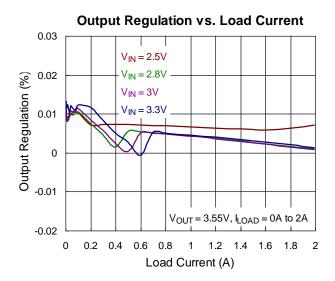
Reference	Description	Manufacturer	Package	Parameter	Тур.	Unit
CIN	10µF/16V/X5R	Taiyo : EMK212ABJ106KG	0805	С	10	μF
COUT	22µF/10V/X5R	Taiyo : LMK212BBJ226MG	0805	С	22	μF
1.4	0.47µH. ±20% TOKO : DFE2520F-R47M		2520	L	0.47	μH
L1	0.47µH, ±20%	TORU . DFE2520F-R47M	2520	DCR (Series R)	29	mΩ

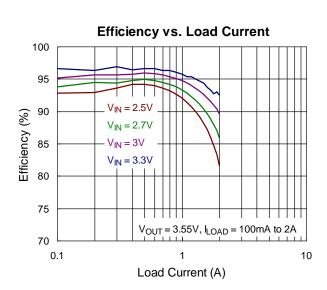
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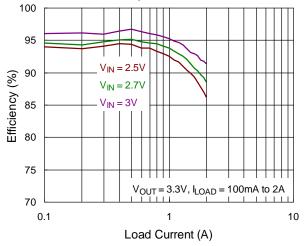
### **Typical Operating Characteristics**

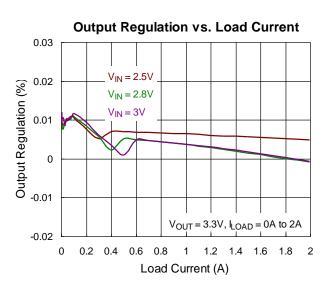






Efficiency vs. Load Current



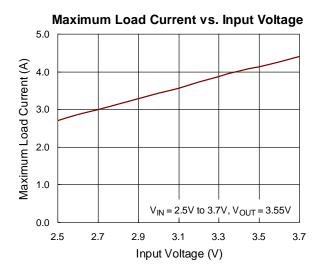


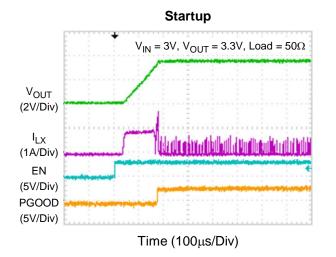
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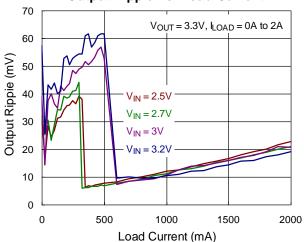
**Output Ripple vs. Load Current** 70  $V_{OUT}$  = 3.55V,  $I_{LOAD}$  = 0A to 2A 60 Output Rippie (mV) √<sub>IN</sub> = 2.5V 50  $V_{IN} = 2.7V$ 40 V<sub>IN</sub> = 3V V<sub>IN</sub> = 3.3V 30 20 10 0 0 500 1000 2000 1500 Load Current (mA)

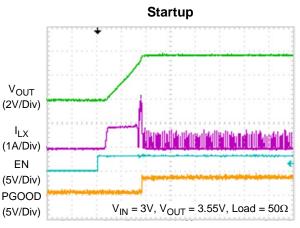




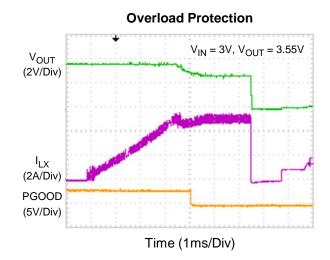
**Output Ripple vs. Load Current** 

**RT4803** 



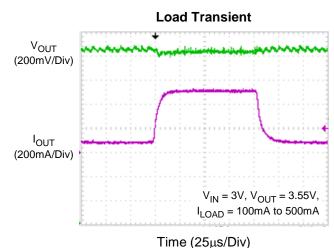


Time (100µs/Div)

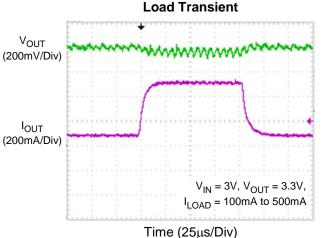


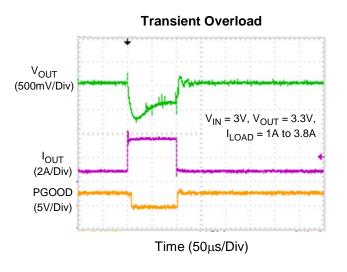
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**Overload Protection** V<sub>OUT</sub> (2V/Div)  $I_{LX}$ (2A/Div) PGOOD (5V/Div) V<sub>IN</sub> = 3V, V<sub>OUT</sub> = 3.3V Time (1ms/Div)



**Transient Overload** 

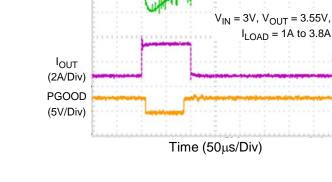




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January 2020

# RICHTEK



VOUT

(500mV/Div)

### **Application Information**

#### Enable

The device can be enabled or disabled by the EN pin. When the EN pin is higher than the threshold of logic-high, the device starts operating with soft-start. Once the EN pin is set at low, the device will be shut down. In shutdown mode, the converter stops switching, internal control circuitry is turned off, and the load is disconnected from the input. This also means that the output voltage can drop below the input voltage during shutdown.

#### Soft-Start State

After the successful completion of the LIN state (V<sub>OUT</sub>  $\geq$  V<sub>IN</sub> – 300mV).

During Soft-Start state, VOUT is ramped up by Boost internal loop. If VOUT fails to reach target value during the Soft-Start period for more than 2ms, a fault condition is declared.

#### **Output Voltage Setting**

User can select the output voltage level by VSEL and I2C. If the VSEL pulled low, the default is 3.3V, and if it pulled high, the default is 3.55V.

The output voltage range is from 2.85V to 4.4V.

### **Power Save Mode**

PSM is the way to improve efficiency at light load.

When the output voltage is lower than a set threshold voltage, the converter will operate in PSM.

It raises the output voltage with several pulses until the loop exits PSM.

### **Under-Voltage Lockout**

The under-voltage lockout circuit prevents the device from operating incorrectly at low input voltages. It prevents the converter from turning on the power switches under undefined conditions and prevents the battery from deep discharge. VIN voltage must be greater than 1.7V to enable the converter. During operation, if VIN voltage drops below 1.6V, the converter is disabled until the supply exceeds the UVLO rising threshold. The RT4803 automatically

restarts if the input voltage recovers to the input voltage UVLO high level.

#### **Thermal Shutdown**

The device has a built-in temperature sensor which monitors the internal junction temperature. If the temperature exceeds the threshold, the device stops operating. As soon as the IC temperature has decreased below the threshold with a hysteresis, it starts operating again. The built-in hysteresis is designed to avoid unstable operation at IC temperatures near the over temperature threshold.

#### Inductor Selection

The recommended nominal inductance value is 0.47μH.

It is recommended to use inductor with dc saturation current ≥ 3500mA

#### Input Capacitor Selection

At least a 10µF input capacitor is recommended to improve transient behavior of the regulator and EMI behavior of the total power supply circuit for LX. And at least a 1µF ceramic capacitor placed as close as possible to the VIN and GND pins of the IC is recommended.

### **Output Capacitor Selection**

At least 22µF x 2 capacitors is recommended to improve Vout ripple.

Output voltage ripple is inversely proportional to COUT.

Output capacitor is selected according to output ripple which is calculated as :

$$\begin{split} & V_{\text{RIPPLE}(\text{P}-\text{P})} = t_{\text{ON}} \times \frac{l_{\text{LOAD}}}{C_{\text{OUT}}} \\ & \text{and} \\ & t_{\text{ON}} = t_{\text{SW}} \times D = t_{\text{SW}} \times \left(1 - \frac{V_{\text{IN}}}{V_{\text{OUT}}}\right) \\ & \text{therefore :} \\ & C_{\text{OUT}} = t_{\text{SW}} \times \left(1 - \frac{V_{\text{IN}}}{V_{\text{OUT}}}\right) \times \frac{l_{\text{LOAD}}}{V_{\text{RIPPLE}(\text{P}-\text{P})}} \\ & \text{and} \\ & t_{\text{SW}} = \frac{1}{f_{\text{SW}}} \end{split}$$

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The maximum  $V_{\text{RIPPLE}}$  occurs when  $V_{\text{IN}}$  is at minimum and  $I_{\text{LOAD}}$  is at maximum.

#### **Output Discharge Function**

With the EN pin set to low, the VOUT pin is internally connected to GND by an internal discharge N-MOSFET switch.

This feature prevents residual charge voltages on capacitor connected to VOUT pins, which may impact proper power up of the system.

#### **Current Limit**

The RT4803 employs a valley-current limit detection scheme to sense inductor current during the off-time. When the loading current is increased such that the loading is above the valley current limit threshold, the off-time is increased until the current is decreased to valley-current threshold. Next on-time begins after current is decreased to valley-current threshold. On-time is decreased to valley-current threshold. On-time is decreases when further loading current increase. As the following figure shown, the current limit function is implemented by the scheme.

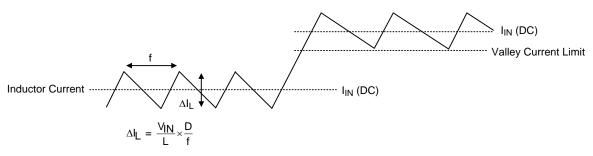


Figure 4. Inductor Currents In Current Limit Operation

### Register Table Lists [Slave address = 1110101 (0x75)]

Name	Address	Description
CONFIG	0x01	MODE control & Spread modulation control
VOUTFLOOR	0x02	Output Voltage Selection
VOUTROOF	0x03	Output Voltage Selection
ILIMSET	0x04	Set current limit & Softstart current limit
STATUS	0x05	Read IC status

### I<sup>2</sup>C Interface

The RT4803 I<sup>2</sup>C slave address is 1110101 (7bits). The I<sup>2</sup>C interface supports fast mode (bit rate up to 400kb/s). The write or read bit stream (N  $\ge$  1) is shown below :

Read N bytes

S Slave Ad	dress 0	A	Register Address	A	Sr	Slave Address	1	1	A MSB	Data 1	LSB A	
	R/W -		Assume Address = m			Data for Addre	ess = m					-
			MSB Data 2	LSE	3 A -	MSB	[	Dat	ta N	LSB A P		
			Data for Address = r	n+1		Data for	Addres	SS	= m + N -	1		
Write N bytes												
S Slave Ad	dress 0	А	Register Address	А	MSB	Data 1	LSB		A MSB	Data 2	LSB A	Ь
	R/₩ 📥		Assume Address = m		Dat	a for Address = m	Da	ata	for Addre	ss = m + 1		
					<b></b>	Data for Addr			ta N	LSB A P		
						Data for / taal	000 - 11	• •				
Driven by Master, Driven by Slave (RT4803), P Stop, S Start, Sr Repeat Start												

Off	set 0x01				CONFIG				
Bits	7	6	5	4	3	2	1	0	
Name	RESET	ENAE	BLE[1:0]	RESERVED	PG Config	ig SSFM MODE_C		CTRL[1:0]	
Reset	0	0	0	0	1	0	0	1	
Туре	RW	RW	RW	RW	RW	RW	RW	RW	
Off	set 0x02				VOUTFLOOR				
Bits	7	6	5	4	3	2	1	0	
Name	RESERVED	RESERVED	RESERVED			VOUT[4: 0]			
Reset	0	0	0	0	1	0	0	1	
Туре	RW	RW	RW	RW	RW	RW	RW	RW	
Off	set 0x03	VOUTROOF							
Bits	7	6	5	4	3	2	1	0	
Name	RESERVED	RESERVED	RESERVED			VOUT[4: 0]			
Reset	0	0	0	0	1	1	1	0	
Туре	RW	RW	RW	RW	RW	RW	RW	RW	
Off	set 0x04				ILIMSET				
Bits	7	6	5	4	3	2	1	0	
Name	RESERVED	RESERVED	ILIM_OFF	SOFT_START		ILIN	<b>/</b> [3:0]		
Reset	0	0	0	1	1	1	1	1	
Туре	RW	RW	RW	RW	RW	RW	RW	RW	
Off	set 0x05				STATUS				
Bits	7	6	5	4	3	2	1	0	
Name	TSD	HOTDIE	DCDCMODE	OPMODE	ILIMPT	ILIMBST	FAULT	PGOOD	
Reset	0	0	0	0	0	0	0	0	
Туре	RO	RO	RO	RO	RO	RO	RO	RO	

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<b>RT4803</b>
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Name		Function	Addr			
CONFIG		MODE control & Spread modulation control	0x01			
Bit	Mode	Name	Reset	Description		
7	R/W	RESET	0	0 : Disable ID detection function 1 : Enable ID detection function		
[6 : 5]	R/W	ENABLE[1 : 0]	0	<ul> <li>00 : Device operation follows hardware control signal (refer to table 1)</li> <li>01 : Device operation in auto transition mode (boost/bypass) regardless of the nBYP control signal (EN = 1)</li> <li>10 : Device is forced in pass-through mode regardless of the nBYP control signal (EN = 1)</li> <li>11 : Device is in shutdown mode. The output voltage is reduced to a minimum value (V<sub>IN</sub> - V<sub>OUT</sub> ≤ 3.6V) regardless of the nBYP control signal (EN = 1)</li> </ul>		
4	R/W	Reserved	0			
3	R/W	PG Config	1	<ul> <li>0 : PG pin = H, Power good indication</li> <li>PG pin = L, IC shut down, it needs retoggle this pin to restart</li> <li>V<sub>OUT</sub></li> <li>1 : PG pin is for power good indication</li> </ul>		
2	R/W	SSFM	0	0 : Spread spectrum modulation is disabled. 1 : Spread spectrum modulation is enabled in PWM mode.		
[1 : 0]	R/W	MODE_CTRL[1:0]	01	<ul> <li>00 : Device operation follows hardware control signal.</li> <li>01 : PFM with automatic transition into PWM operation.</li> <li>10 : Forced PWM operation.</li> <li>11 : PFM with automatic transition into PWM operation (VSEL = L), forced PWM operation (VSEL = H).</li> </ul>		
Na	me	Function	Addr			
VOUT	FLOOR	Output Voltage Selection	0x02			
Bit	Mode	Name	Reset	Description		
[7 : 5]	R/W	Reserved	000			
$\begin{bmatrix} [4:0] \\ [4$		00001 : V <sub>OUT</sub> = 2.9V 00010 : V <sub>OUT</sub> = 2.95V 00011 : V <sub>OUT</sub> = 3V 00100 : V <sub>OUT</sub> = 3.05V  01001 : V <sub>OUT</sub> = 3.3V (default) 				

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Name		Function	Addr			
VOUTROOF		Output Voltage Selection	0x03			
Bit Mode Name		Reset	Description			
[7 : 5]	R/W	Reserved	000			
[4 : 0]	R/W	VOUT[4 : 0]	01110	$\begin{array}{l} 00000: V_{OUT} = 2.85V\\ 00001: V_{OUT} = 2.9V\\ 00010: V_{OUT} = 2.95V\\ 00011: V_{OUT} = 3V\\ 00100: V_{OUT} = 3.05V\\ \ldots\\ 01110: V_{OUT} = 3.55V \text{ (default)}\\ \ldots\\ 11111: V_{OUT} = 4.4V \end{array}$		
Na	me	Function	Addr			
ILIMSET		Set current limit & Soft-start current limit	0x04			
Bit	Mode	Name	Reset	Description		
[7:6]	R/W	Reserved	00			
5	R/W	ILIM_OFF	0	0 : Current Limit Enabled 1 : Current Limit Disabled		
4	R/W	Soft-Start	1	<ul> <li>0 : Boost soft-start current is limited per ILIM bit settings</li> <li>1 : Boost soft-start current is limited to ca. 1250mA inductor valley current</li> </ul>		
[3 : 0]	R/W	ILIM[3 : 0]	1111	1000 : 1500mA 1001 : 2000mA 1010 : 2500mA 1011 : 3000mA 1100 : 3500mA 1110 : 4500mA 1110 : 4500mA 1111 : 5000mA (default)		

Name		Function	Addr			
STA	TUS	Read IC status	0x05			
Bit	Mode	Name	Reset	Description		
7	R	TSD	0	0 : Normal operation. 1 : Thermal shutdown tripped. The flag is reset after readout.		
6	R	HOTDIE	0	0 : TJ < 115°C. 1 : TJ > 115°C.		
5	R	DCDCMODE	0	0 : Device operates in PFM mode. 1 : Device operates in PWM mode.		
4	R	OPMODE	0	0 : Device operates in pass-through mode. 1 : Device operates in dc/dc mode.		
3	R	ILIMPT	0	<ul><li>0 : Normal operation.</li><li>1 : Indicates that the bypass FET current limit has triggered. This flag is reset after readout.</li></ul>		
2	R	ILIMBST	0	<ul> <li>0 : Normal operation.</li> <li>1 : Indicates that the average input current limit has triggered for 1.5ms in dc/dc boost mode. This flag is reset after readout.</li> </ul>		
1	R	FAULT	0	<ul> <li>0 : Normal operation.</li> <li>1 : Indicates that a fault condition has occurred. This flag is reset after readout.</li> </ul>		
0	R	PGOOD	0	<ul><li>0 : Indicates the output voltage is out of regulation.</li><li>1 : Indicates the output voltage is within its nominal range. This bit is set if the converter is forced in pass-through mode.</li></ul>		

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#### **Thermal Considerations**

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula :

 $P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$ 

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance,  $\theta_{JA}$ , is layout dependent. For WL-CSP-16B 1.67x1.67 (BSC) package, the thermal resistance,  $\theta_{JA}$ , is 47.7°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at  $T_A = 25$ °C can be calculated by the following formula :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (47.7^{\circ}C/W) = 2.09W$  for WL-CSP-16B 1.67x1.67 (BSC) package

The maximum power dissipation depends on the operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance,  $\theta_{JA}$ . The derating curve in Figure 5 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

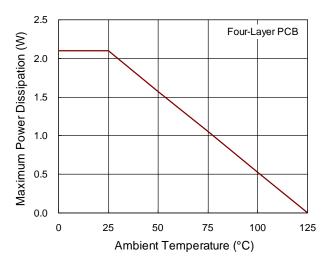


Figure 5. Derating Curve of Maximum Power Dissipation

The PCB layout is an important step to maintain the high performance of the RT4803.

Both the high current and the fast switching nodes demand full attention to the PCB layout to save the robustness of the RT4803 through the PCB layout. Improper layout might show the symptoms of poor line or load regulation, ground and output voltage shifts, stability issues, unsatisfying EMI behavior or worsened efficiency. For the best performance of the RT4803, the following PCB layout guidelines must be strictly followed.

- Place the input and output capacitors as close as possible to the input and output pins respectively for good filtering.
- ► For thermal consider, it needed to maximize the pure area for the power stage area besides the LX.

**Layout Consideration** 

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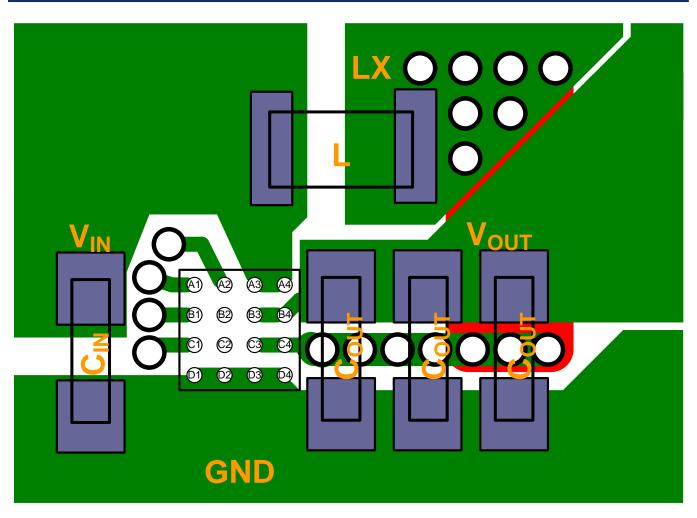
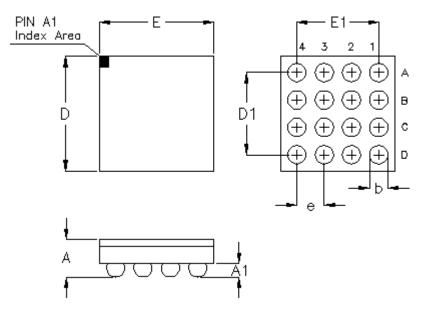


Figure 6. PCB Layout Guide

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### **Outline Dimension**



Symphol	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min	Мах	Min	Мах	
A	0.500	0.600	0.020	0.024	
A1	0.170	0.230	0.007	0.009	
b	0.240	0.300	0.009	0.012	
D	1.620	1.720	0.064	0.068	
D1	1.2	200	0.047		
E	1.620	1.720	0.064	0.068	
E1	1.2	200	0.047		
е	0.4	100	0.016		

WL-CSP-16B 1.67x1.67 (BSC)

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